

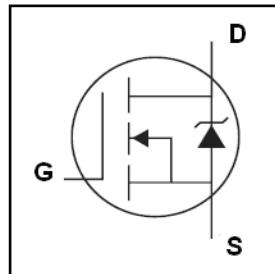


## Features

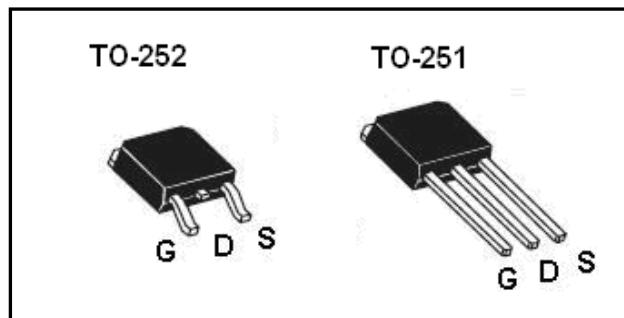
- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ 100% Avalanche Tested
- ◆ Repetitive Avalanche Allowed up to  $T_{jmax}$
- ◆ Lead-Free, RoHS Compliant

## Description

VS6038AD designed by the trench processing techniques to achieve extremely low on-resistance. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Power applications and a wide variety of other supply applications.



$V_{DSS}$	60V
$R_{DS(on)}$	35 mΩ
$I_D$	25A



## Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (T<sub>c</sub>=25°C Unless Otherwise Noted)</b>				
$V_{GS}$	Gate-Source Voltage	±20	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	60	V	
$T_J$	Maximum Junction Temperature	175	°C	
$T_{STG}$	Storage Temperature Range	-55 to 175	°C	
$I_S$	Diode Continuous Forward Current	$T_c = 25^\circ\text{C}$	25	A

## Mounted on Large Heat Sink

$I_{DM}$	Pulse Drain Current Tested ①	$T_c = 25^\circ\text{C}$	100	A
$I_D$	Continuous Drain current@ $V_{GS}=10\text{V}$	$T_c = 25^\circ\text{C}$	25	A
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ\text{C}$	35	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case		3	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		75	°C/W

## Drain-Source Avalanche Ratings

EAS	Avalanche Energy, Single Pulsed ②	38	mJ
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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_c=25^\circ\text{C}$ )	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_c=125^\circ\text{C}$ )	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 16\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 10$	$\mu\text{A}$
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.0	1.6	2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance <sup>③</sup>	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=16\text{A}$	--	35	45	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance <sup>③</sup>	$V_{\text{GS}}=5\text{V}, I_{\text{D}}=8\text{A}$	--	38	55	$\text{m}\Omega$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=25\text{V}, I_{\text{D}}=18\text{A}$	--	25	--	S
<b>Dynamic Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	--	650	--	pF
$C_{\text{oss}}$	Output Capacitance		--	95	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	60	--	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=18\text{A}, V_{\text{GS}}=10\text{V}$	--	20	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	7	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	5	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=30\text{V}, I_{\text{D}}=1\text{A}, R_{\text{G}}=6.8\Omega, V_{\text{GS}}=10\text{V}$	--	18	--	nS
$t_r$	Turn-on Rise Time		--	15	--	nS
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	60	--	nS
$t_f$	Turn-Off Fall Time		--	31	--	nS
<b>Source- Drain Diode Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$I_{\text{SD}}$	Source-drain current(Body Diode)	$T_c=25^\circ\text{C}$	--	--	25	A
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=20\text{A}, V_{\text{GS}}=0\text{V}$	--	--	1.3	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{sd}}=20\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$	--	65	--	nS
$Q_{\text{rr}}$	Reverse Recovery Charge			85		nC

**NOTE:**

① Repetitive rating; pulse width limited by max. junction temperature.

② Limited by  $T_{J\text{max}}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.3\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 16\text{A}$ ,  $V_{GS} = 10\text{V}$ . Part not recommended for use above this value

③ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .



## Typical Characteristics

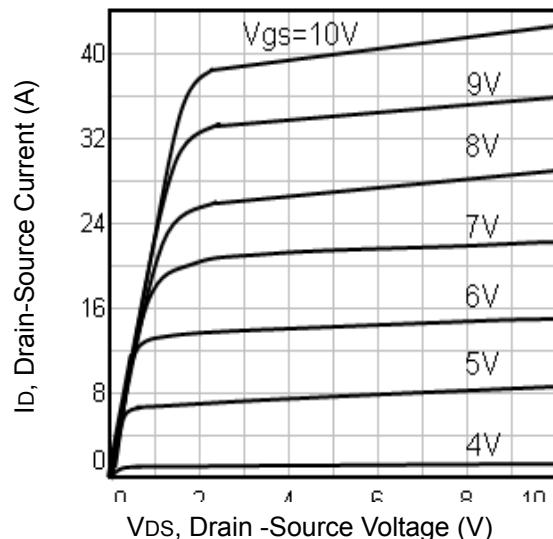


Fig1. Typical Output Characteristics

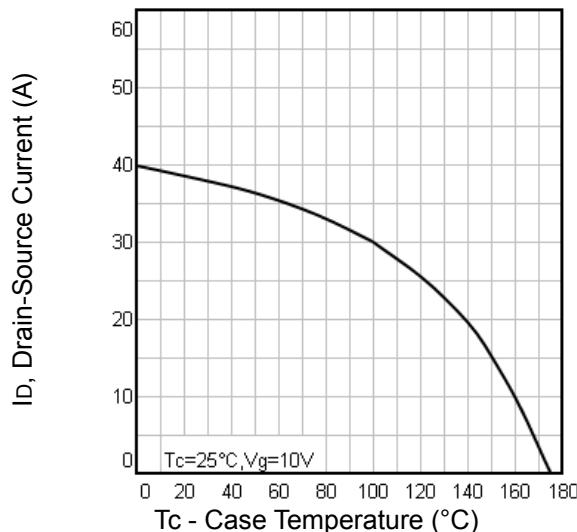


Fig2. Maximum Drain Current Vs. Case Temperature

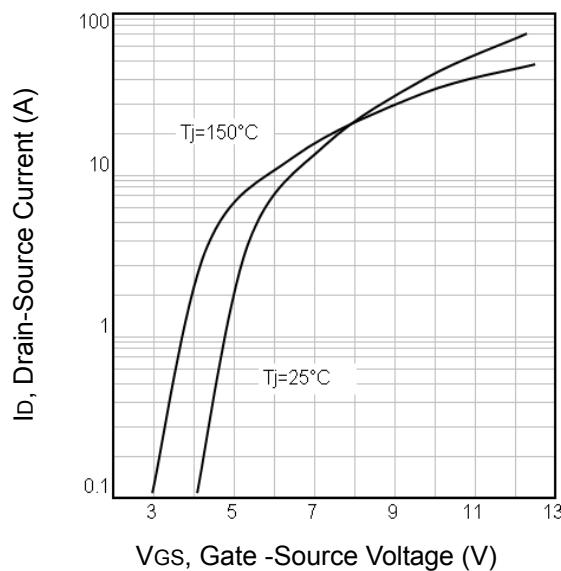


Fig3. Typical Transfer Characteristics

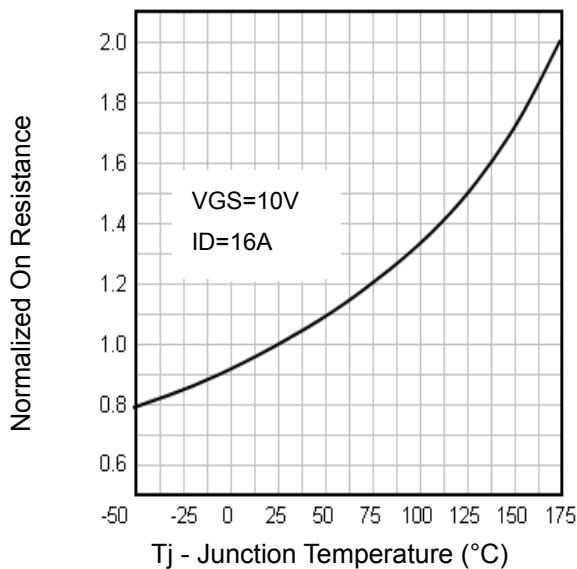


Fig4. Normalized On-Resistance Vs. Temperature

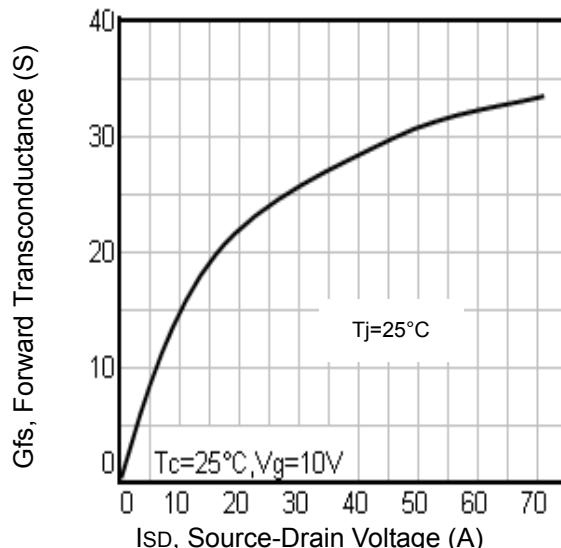


Fig5. Typical Forward Transconductance Vs. Drain Current

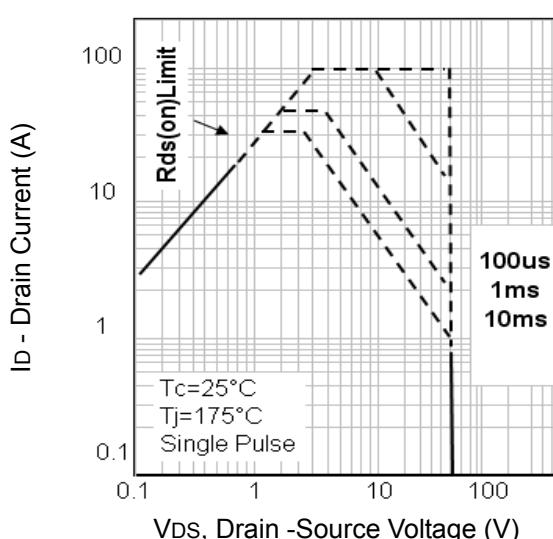


Fig6. Maximum Safe Operating Area



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**VS6038AD**

**60V/25A N-Channel Advanced Power MOSFET**

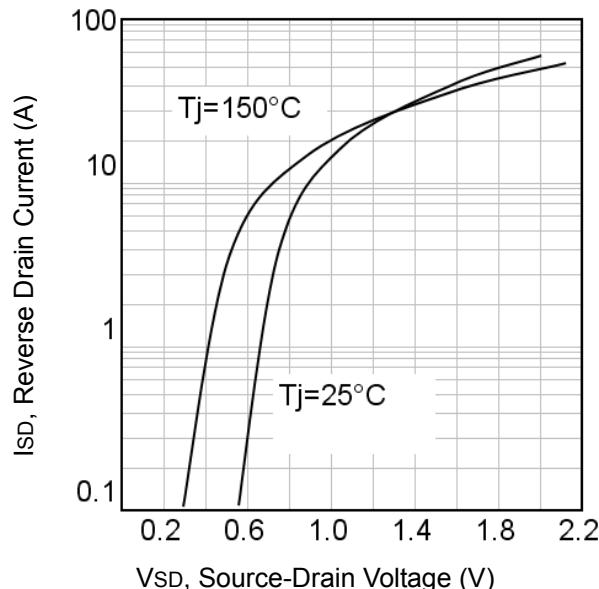


Fig7. Typical Source-Drain Diode Forward Voltage

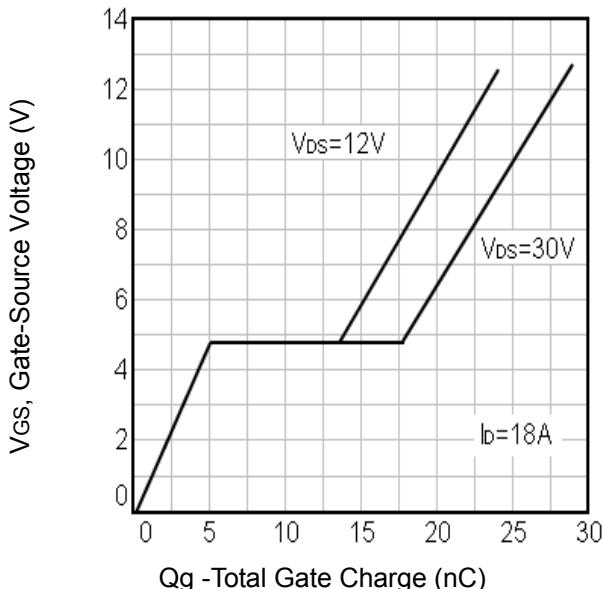


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

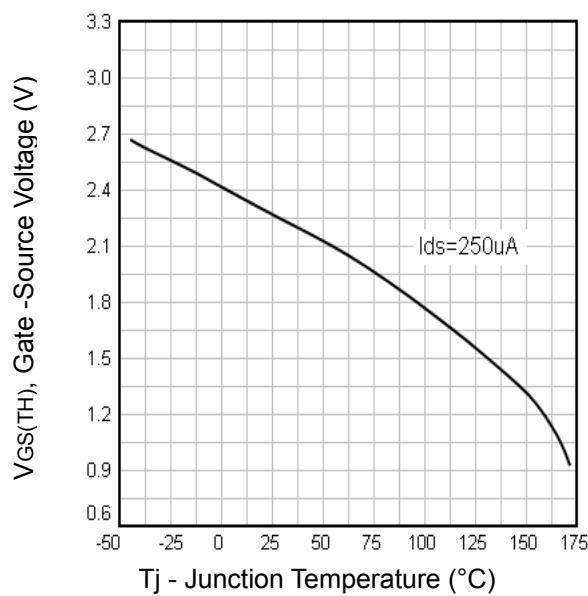


Fig9. Threshold Voltage Vs. Temperature

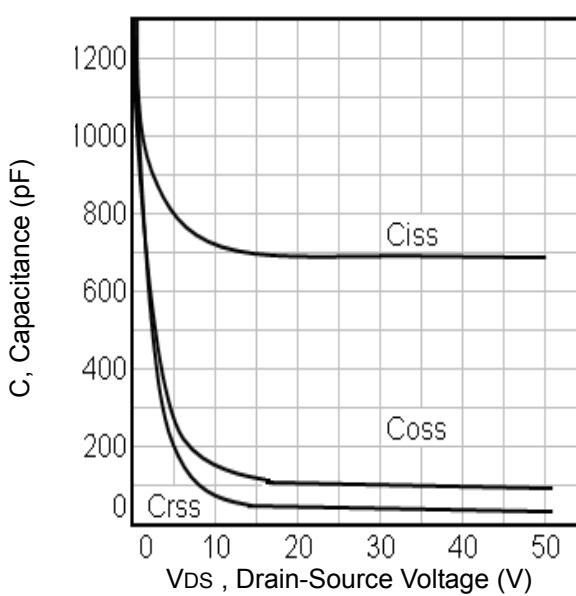


Fig10. Typical Capacitance Vs.Drain-Source Voltage

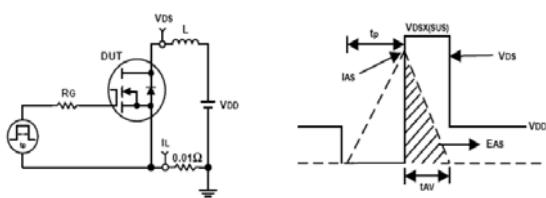


Fig11. Unclamped Inductive Test Circuit and waveforms

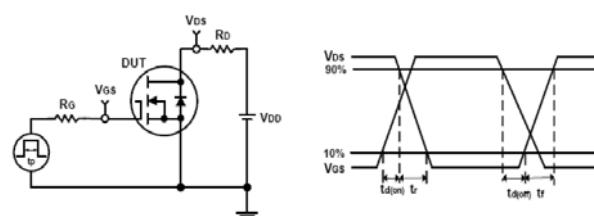


Fig12. Switching Time Test Circuit and waveforms

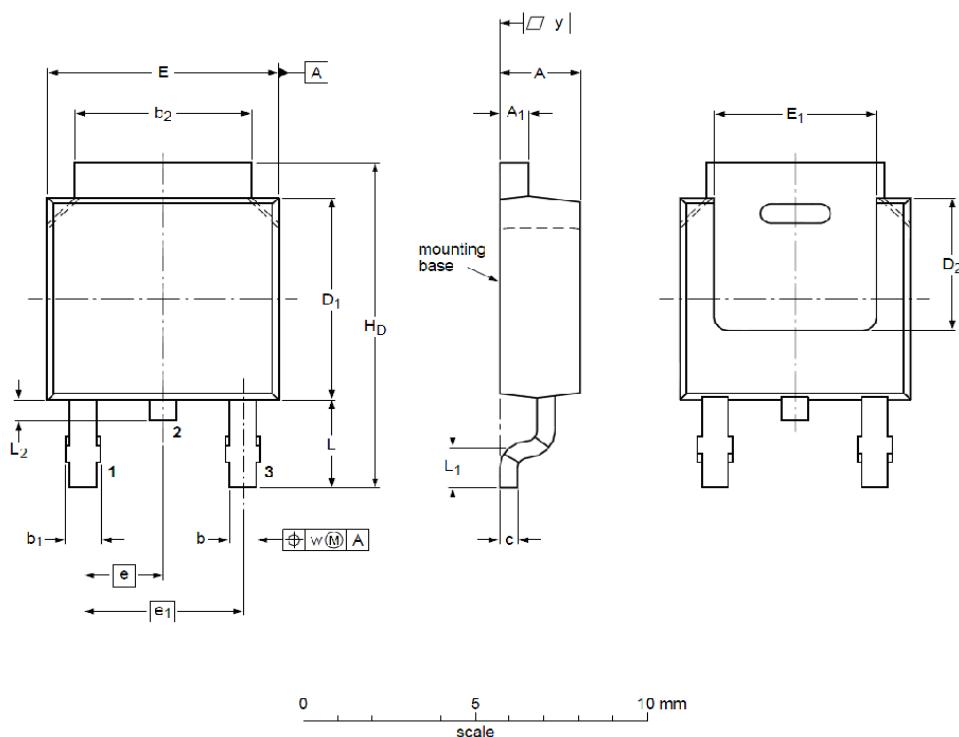


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VS6038AD

60V/25A N-Channel Advanced Power MOSFET

## TO-252 Package Outline Data



### DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	2.22	2.30	2.38	A <sub>1</sub>	0.46	0.58	0.93
b	0.71	0.79	0.89	b <sub>1</sub>	0.90	0.98	1.10
b <sub>2</sub>	5.00	5.30	5.46	c	0.20	0.40	0.56
D <sub>1</sub>	5.98	6.05	6.22	D <sub>2</sub>	--	4.00	--
E	6.47	6.60	6.73	E <sub>1</sub>	5.10	5.28	5.45
e	--	2.28	--	e <sub>1</sub>	--	4.57	--
H <sub>D</sub>	9.60	10.08	10.40	L	2.75	2.95	3.05
L <sub>1</sub>	--	0.50	--	L <sub>2</sub>	0.80	0.90	1.10
w	--	0.20	--	y	0.20	--	--

### Order Information

Product	Marking	Package	Packaging	Min Unit Quantity
VS6038AD	6038AD	TO-252	2500/Reel	5000

### Customer Service

#### Sales and Service:

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